MOSFET – Power, Dual, **N-Channel 40 V. 2.65 m**Ω. 145 A

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant



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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
40 V	$2.65~\mathrm{m}\Omega$ @ 10 V	
	3.9 mΩ @ 4.5 V	145 A

Parameter Symbol Value Unit Drain-to-Source Voltage V_{DSS} 40 V V Gate-to-Source Voltage V_{GS} ±20 Continuous Drain $T_{\rm C} = 25^{\circ}{\rm C}$ 145 A I_D Current R_{0JC} $T_{\rm C} = 100^{\circ}{\rm C}$ 105 (Notes 1, 2, 3) Steady State Power Dissipation $T_C = 25^{\circ}C$ P_D 125 W R_{0JC} (Notes 1, 2) $T_{\rm C} = 100^{\circ}{\rm C}$ 62 T_A = 25°C **Continuous Drain** 25 A I_D Current $R_{\theta JA}$ (Notes 1, 2, 3) $T_A = 100^{\circ}C$ 18 Steady State Power Dissipation T_A = 25°C P_{D} 3.5 W R_{0JA} (Notes 1 & 2) $T_A = 100^{\circ}C$ 1.8 **Pulsed Drain Current** 644 $T_A = 25^{\circ}C, t_p = 10 \ \mu s$ А I_{DM} °C Operating Junction and Storage Temperature T_J, T_{sta} -55 to + 175 Source Current (Body Diode) 91 А Is E_{AS} Single Pulse Drain-to-Source Avalanche 171 mJ Energy $(I_{L(pk)} = 11 \text{ A})$ Lead Temperature for Soldering Purposes ΤL 260 °C (1/8" from case for 10 s)

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

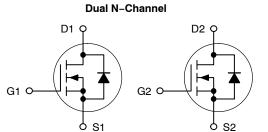
THERMAL RESISTANCE MAXIMUM RATINGS

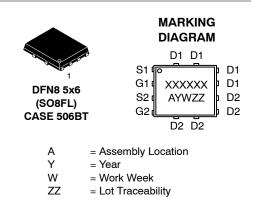
Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	1.38	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	46.9	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.





ORDERING INFORMATION

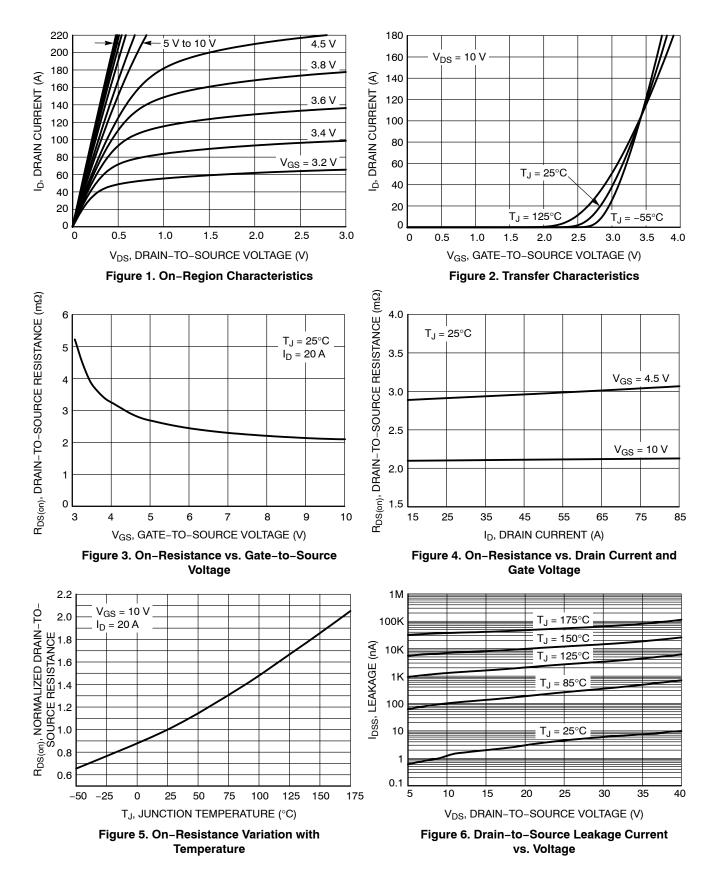
See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

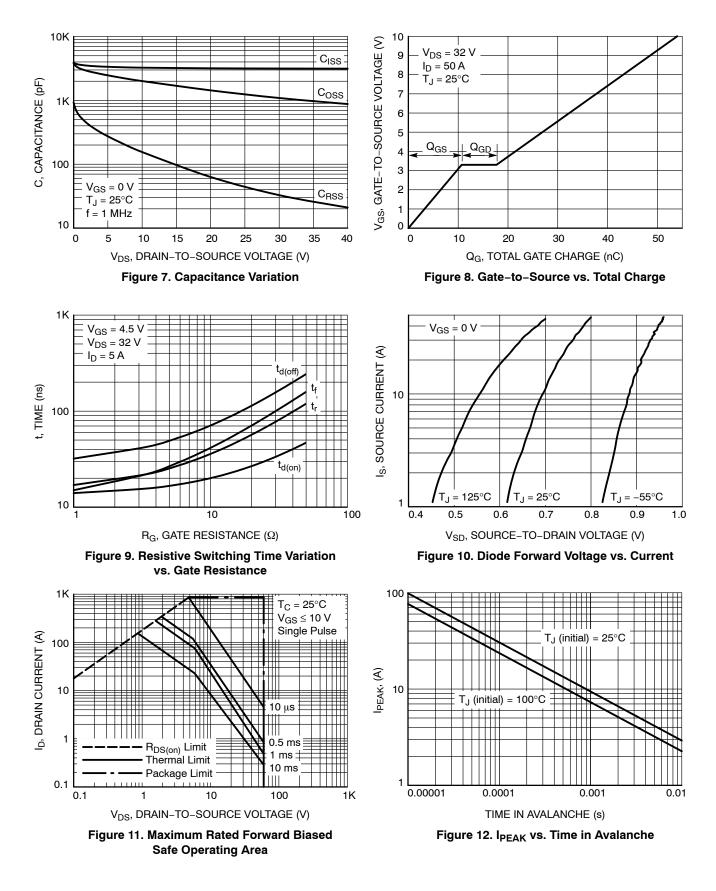
Parameter	Symbol	Test Condi	tion	Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D = 250 μ A		40			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				23		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = 40 V	T _J = 25 °C			10	μΑ
			T _J = 125°C			100	
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} = 20 V				100	nA
ON CHARACTERISTICS (Note 4)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}$, $I_D = 90 \ \mu A$		1.2		2.2	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-5.2		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 20 A		2.2	2.65	mΩ
		V _{GS} = 4.5 V	I _D = 20 A		3.0	3.9	
Forward Transconductance	9 _{FS}	V _{DS} = 15 V, I _D = 50 A			138		S
CHARGES, CAPACITANCES & GATE RESIS	TANCE			-		-	-
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 25 V			3170		
Output Capacitance	C _{OSS}				1270		pF
Reverse Transfer Capacitance	C _{RSS}				48		
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 4.5 V, V_{DS} = 32 V; I_{D} = 50 A			25		1
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 10 V, V_{DS} = 32 V; I_{D} = 50 A			54		
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 4.5 V, V _{DS} = 32 V; I _D = 50 A			5.7		nC
Gate-to-Source Charge	Q _{GS}				10.7		
Gate-to-Drain Charge	Q _{GD}				7.0		
Plateau Voltage	V _{GP}				5.7		V
SWITCHING CHARACTERISTICS (Note 5)							
Turn–On Delay Time	t _{d(ON)}				14.8		
Rise Time	t _r	V_{GS} = 4.5 V, V_{DS} = 32 V, I_{D} = 5 A, R_{G} = 1.0 Ω			16.8		- ns
Turn-Off Delay Time	t _{d(OFF)}				34.9		
Fall Time	t _f				15.2		
DRAIN-SOURCE DIODE CHARACTERISTIC	s			-		-	-
Forward Diode Voltage	V _{SD}	$V_{GS} = 0 V,$ $I_{S} = 20 A$	$T_J = 25^{\circ}C$		0.8		.,
			T _J = 125°C		0.7		V
Reverse Recovery Time	t _{RR}	$V_{GS} = 0 \text{ V, } dI_S/dt = 50 \text{ A/}\mu\text{s},$ $I_S = 5 \text{ A}$			54		ns
Charge Time	t _a				24		
Discharge Time	t _b				30		
Reverse Recovery Charge	Q _{RR}				55		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: pulse width $\leq 300 \ \mu$ s, duty cycle $\leq 2\%$. 5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

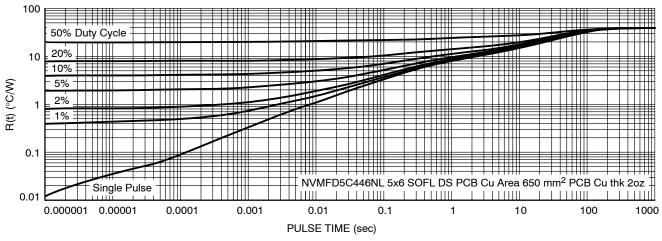


Figure 13. Thermal Characteristics

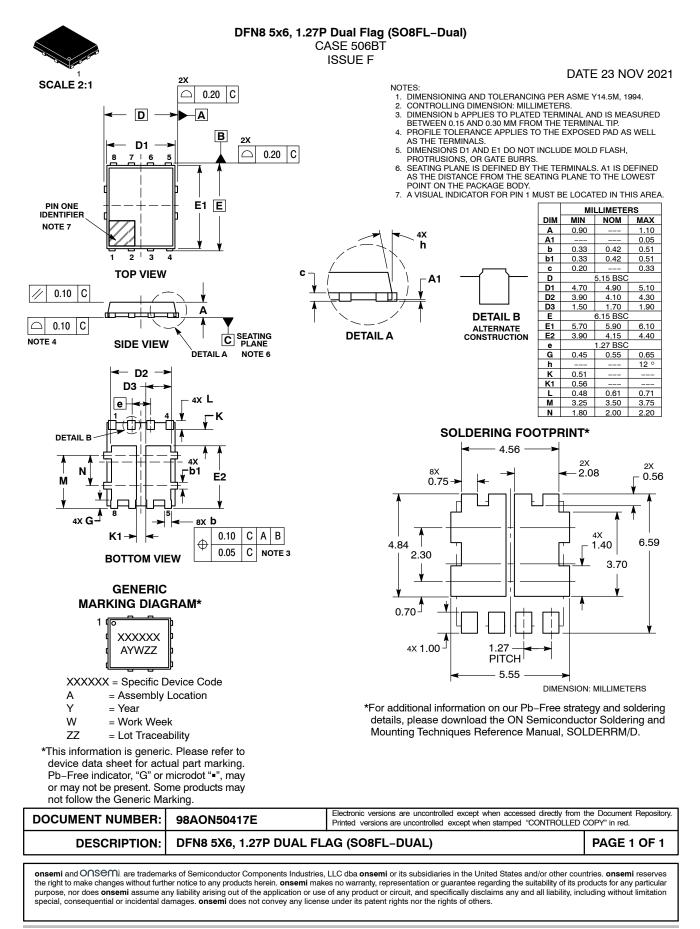
DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NTMFD5C446NLT1G	5C446L	DFN8 (Pb–Free)	1500 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

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